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STATEMENT UNDER 37 CFR 3.73(b)			
Applicant/Patent Owner: Yil-Suk Yang			
Application No./Patent No.: 6.252,527 Filed/lesue Date: 06/26/2001			
Titled: INTERFACE UNIT FOR SERIAL-TO-PARALLEL CONVERSION AND/OR PARALLEL-TO-SERIAL CONVERSION			
Intellectual Ventures II LLC . a Limited Liability Company			
(Name of Assignee) (Type of Assignee, e.g., corporation, partnership, university, government agency, etc.	~		
states that it is:			
1. X the assignee of the entire right, title, and interest in;			
an assignee of less than the entire right, title, and interest in (The extent (by percentage) of its ownership interest is			
3 the assignee of an undivided interest in the entirety of (a complete assignment from one of the joint inventors was made)			
the patent application/patent identified above, by virtue of either:			
An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the United States Patent and Trademark Office at Reel, Frame, or for which a copy therefore is attached.			
OR B. X A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as follows:			
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3. From: Hyundai Micro electronics Co., LTD. To: Hyundai Electronics Industries Co., LTD			
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Additional documents in the chain of title are listed on a supplemental sheet(s).			
As required by 37 CFR 3.73(b)(1)(i), the documentary evidence of the chain of title from the original owner to the assignee vor concurrently is being, submitted for recordation pursuant to 37 CFR 3.11. [NOTE: A separate copy (i.e., a true copy of the original assignment document(s)) must be submitted to Assignment Division accordance with 37 CFR Part 3, to record the assignment in the records of the USPTO. See MPEP 302.08] The indexsigned (whose life is supplied below) is authorized to act on behalf of the assignee.			
Signature Oate			
David Dutcher, Authorized Person for Intellectual Ventures II LLC Printed or Typed Name Title			

This collection of information is required by 37 CFR 3.73(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will very depending upon the individual case. Any comments on the emount of time you require to complete this form and/or suggrestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. 8ox 1450, Alexandria, VA. 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. BEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

STATEMENT UNDER 37 CFH 3.73(b) - SUPPLEMENTAL SHEET

Conti	nuation	of chain of title from the inventor(s), of the patent application/patent to the current assignee as follows:
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13.	From:	To:
14.	From:	To:
15.	From:	To:
16.	From:	To: